505677664 09/18/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5724472

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LEI CHANG	03/29/2013
TAO MA	03/29/2013
ZHANWEI WANG	03/29/2013
LIRONG JIAN	03/29/2013
LILI MA	03/29/2013
GAVIN SHERRY	03/29/2013

RECEIVING PARTY DATA

Name:	EMC CORPORATION
Street Address:	176 SOUTH STREET
City:	HOPKINTON
State/Country:	MASSACHUSETTS
Postal Code:	01748

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16573925

CORRESPONDENCE DATA

Fax Number: (408)973-2595

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 4089732585

Email: enguyen@ip-patent.com

VAN PELT, YI & JAMES LLP AND EMC IP HOLDING COMPA **Correspondent Name:**

10050 N. FOOTHILL BLVD. Address Line 1:

Address Line 2: SUITE 200

Address Line 4: CUPERTINO, CALIFORNIA 95014

ATTORNEY DOCKET NUMBER:	EMCCP475C2
NAME OF SUBMITTER:	DANIEL M SCHNEIDER
SIGNATURE:	/Daniel M. Schneider/
DATE SIGNED:	09/18/2019

PATENT REEL: 050411 FRAME: 0937 505677664

Total Attachments: 8 source=EMCCP475C2 Executed Assignment#page1.tif source=EMCCP475C2 Executed Assignment#page2.tif source=EMCCP475C2 Executed Assignment#page3.tif source=EMCCP475C2 Executed Assignment#page4.tif source=EMCCP475C2 Executed Assignment#page5.tif source=EMCCP475C2 Executed Assignment#page6.tif source=EMCCP475C2 Executed Assignment#page7.tif source=EMCCP475C2 Executed Assignment#page8.tif

PATENT REEL: 050411 FRAME: 0938

ASSIGNMENT

WHEREAS, we, Lei Chang, Tao Ma, Zhanwei Wang, Lirong Jian, Lili Ma and Gavin Sherry have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled PLUGGABLE STORAGE SYSTEM FOR DISTRIBUTED FILE SYSTEMS, the specification of which:

	is being executed on even date herewith and is about to be filed in the United States Patent Office;
[X]	was filed on March 15, 2013 as U.S. Application No. 13/843,067;
[]	was patented under U.S. Patent Noon

WHEREAS, EMC Corporation (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of the Commonwealth of Massachusetts and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein:

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including

PATENT REEL: 050411 FRAME: 0939 the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

PATENT/Joint Assignment EMC Docket No.: EMC-13-0199(PRO)ORD3

Date: 2017. 3.2	La CHANG	
	Inventor's Signature	
Print full name of first inventor:	Lei Chang	
Residence:	Beijing, People's Republic of China	
Citizenship:	People's Republic of China	
Mailing Address:	Room 661, Building 18, MaDianNanCun	3
	Xicheng District, Beijing, China	
I Shengwen Yang	(name) whose residential address is	
Room 801, Building 7, Jin Dian Hua Y	<u> Yuan, Haidian District, Beijing 100082, China</u>	
	Lei Chang (name of person signing the ass	signment)
who is personally known to me, execute Shenguan (my	e the above assignment. (signature of first witness) Signed at	Block D,
	g, China (location of witness signature) o	
Mar. 29 of 2013 . (date of signature	re)	
I Jin Wang	(name) whose residential address is	
	istrict, Beijing, China was personally presen	t and did
see <u>Lei Chang</u>	(name of person signing the assign	ument)
who is personally known to me, execute	e the above assignment. (signature of second witness) Signed atG	/F, Block
	ijing, China (location of witness signatur	
day Mar. 29 of 2013 (date of s	signature)	

Date: Mar. 29, 2013	Tao Ma
a	Inventor's Signature
Print full name of second inventor:	Tao Ma
Residence:	Beijing, People's Republic of China
Citizenship:	People's Republic of China
Mailing Address:	Rm 413, No.35 North 4th Ring Middle Rd,
	Chaoyao Distinct, Beijing, China
I Shengwen Yang	(name) whose residential address is
Room 801, Building 7, Jin Dian Hua Yuan	n, Haidian District, Beijing 100082, China
was personally present and did seeTae	o Ma (name of person signing the
assignment)	
who is personally known to me, execute the	e above assignment. nature of first witness) Signed at G/F, Block D,
	China (location of witness signature) on this day
Mar. 29 of 2013 . (date of signature)	
I <u>Jin Wang</u>	(name) whose residential address is
No.15, Wangzhuang Road, Haidian Distri	ct, Beijing, China was personally present and did
see <u>Tao Ma</u>	(name of person signing the assignment)
who is personally known to me, execute the	ne above assignment.
	nature of second witness) Signed at G/F, Block
•••	g. China (location of witness signature) on this
day Mar. 29 of 2013 . (date of sign	natura)

Date: Mod. 29, 2013	Zhanwei Wang	
	Inventor's Signatu	ıre
Print full name of third inventor:	Zhanwei Wang	
Residence:	Beijing, People's Republic of China	
Citizenship:	People's Republic of China	
Mailing Address:	Room 10, Unit 2, Building 2, XiWai	
	Taipingzhuang, HaiDian district, Be	ijing, China
I <u>Shengwen Yang</u>	(name) whose residential addres	s is
Room 801, Building 7, Jin Dian Hu	a Yuan, Haidian District, Beijing 100082, Chins	3
was personally present and did see _	Zhanwei Wang (name of person signing th	ne assignment)
who is personally known to me, exec Therewen Yarly	oute the above assignment(signature of first witness) Signed at	G/F. Block D.
No. 1 Zhongguancun East Road, Bei	ijing, China (location of witness signatu	ıre) on this day
<u>Mar. 29</u> of 20 <u>13</u> . (date of sign	ature)	
I <u>Jin Wang</u>	(name) whose residential address	s îs
No.15, Wangzhuang Road, Haidian	District, Beijing, China	
was personally present and did see _	Zhanwei Wang (name of person signing the	he assignment)
who is personally known to me, exec	cute the above assignment.	
Vin Werl	(signature of second witness) Signed at	G/F, Block
***	Beijing, China (location of witness sign	
day Mar. 29 of 2013 (date	of signature)	

Date: Mar, 29, 2013	<u>) j`Vong</u> <u>) j`a/</u> Inventor's Signa	
	J Inventor's Signa	ture
Print full name of fourth inventor:	Lirong Jian	
Residence:	Beijing, People's Republic of Chin	a
Citizenship:	People's Republic of China	
Mailing Address:	Rm 301, Unit 5, Building 10, Beiji	ng Forestry
	University, Beijing, China	
I Shengwen Yang	(name) whose residential addre	ess is
Room 801, Building 7, Jin Dian Hua Yua	an, Haidian District, Beijing 100082, Chi	<u>na</u>
was personally present and did see Lin	rong Jian (name of person signing	the assignment)
who is personally known to me, execute the supplemental execute the sup	he above assignment. gnature of first witness) Signed at	G/F, Block D.
No. 1 Zhongguancun East Road, Beijing,		
Mar. 29 of 2013 (date of signature))	
I Jin Wang	(name) whose residential addre	ss is
No.15, Wangzhuang Road, Haidian Distr	rict, Beijing, China was personally pr	esent and did see
Lirong Jian (name of p	erson signing the assignment)	
who is personally known to me, execute t	he above assignment.	
Jin Wang (si	gnature of second witness) Signed at	G/F, Block
D. No. 1 Zhongguancun East Road, Beijii		
day Mar. 29 of 2013 (date of sig	mature)	

Date: 2013. 3. 29	libi Ma
	Inventor's Signature
Print full name of fifth inventor:	Lili Ma
Residence:	Beijing, People's Republic of China
Citizenship:	People's Republic of China
Mailing Address:	Guan Ting Yuan, Hui Long Guan, Chang Ping
	District, Beijing, China
I <u>Shengwen Yang</u>	(name) whose residential address is
Room 801, Building 7, Jin Dian Hua Yu	an, Haidian District, Beijing 100082, China was
personally present and did see Lili Ma	(name of person signing the assignment)
who is personally known to me, execute	the above assignment. ignature of first witness) Signed at
No. 1 Zhongguancun East Road, Beijing	. China (location of witness signature) on this day
Mar. 29 of 2013 . (date of signature	
I Jin Wang	(name) whose residential address is
No.15, Wangzhuang Road, Haidian Dist	rict, Beijing, China was personally present and did see
Lili Ma	(name of person signing the assignment)
who is personally known to me, execute	the above assignment.
Jin Worney (s	ignature of second witness) Signed atG/F, Block
•	ing, China (location of witness signature) on this
day Mar. 29 of 2013 . (date of si	gnature)

PATENT/Joint Assignment EMC Docket No.: EMC-13-0199(PRO)ORD3

Date: 3-29-13 Inventor's Signature Gavin Sherry Print full name of sixth inventor: Residence: San Matco, CA Australia Citizenship: 229 S Eldorado Strect Mailing Address:

San Mateo, CA 94401

STATE OF COUNTY OF

On this <u>39</u> day of <u>MAY</u>, 20 13, before me appeared <u>GAVIN SHERRY</u> who proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ics), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

I certify under PENALTY OF PERJURY under the laws of the State of California that the foregoing paragraph is true and correct.

WITNESS my hand and official scal.

CATHERINE F. BEAULIEU Commission # 1978561 Notary Public - California San Mateo County My Comm. Expires May 18, 2016

Notary Public
Print Name: <u>CATHERINE F. BEAU</u>UEU

My Commission expires <u>5</u> / <u>18</u> / <u>1</u> <u>1</u> <u>6</u>

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